Quad single-pole single-throw analog switch

Rev. 2 — 4 April 2013

Product data sheet

1. General description

The 74HC4066-Q100; 74HCT4066-Q100 is a quad single pole, single throw analog switch. Each switch features two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels nE inputs:
 - For 74HC4066-Q100: CMOS level
 - For 74HCT4066-Q100: TTL level
- Low ON resistance:
 - 50 Ω (typical) at V_{CC} = 4.5 V
 - 45 Ω (typical) at V_{CC} = 6.0 V
 - 35 Ω (typical) at V_{CC} = 9.0 V
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - ◆ MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)
- Multiple package options

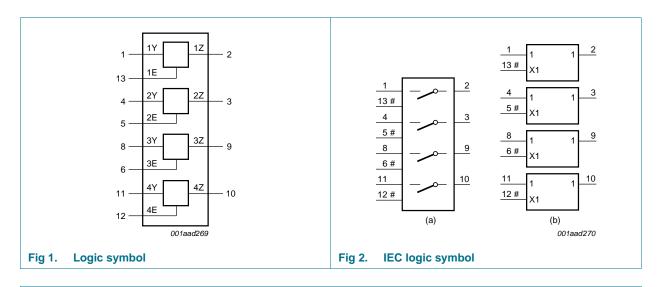


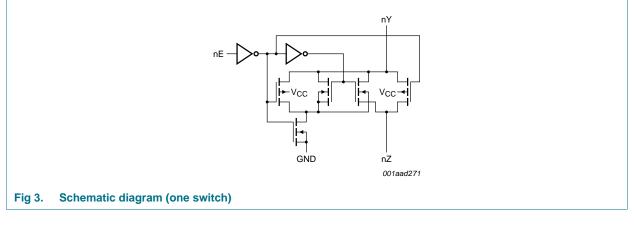
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3. Ordering information

Table 1. Ordering information									
Type number	Package								
	Temperature range	Name	Description	Version					
74HC4066D-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width	SOT108-1					
74HCT4066D-Q100			3.9 mm						
74HC4066PW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1					
74HCT4066PW-Q100			body width 4.4 mm						
74HC4066BQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced	SOT762-1					
74HCT4066BQ-Q100			very thin quad flat package; no leads; 14 terminals; body 2.5 \times 3 \times 0.85 mm						

4. Functional diagram

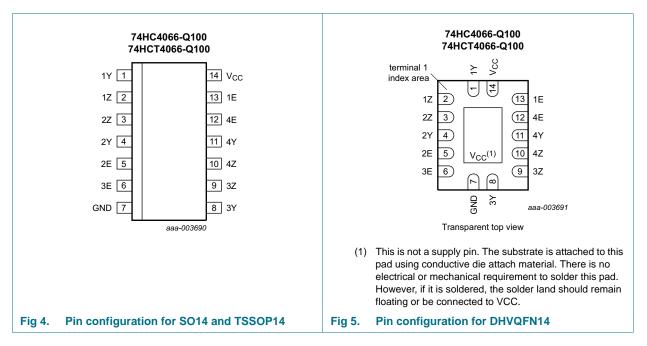




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5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2. Pin description	l i i i i i i i i i i i i i i i i i i i	
Symbol	Pin	Description
1Z, 2Z, 3Z, 4Z	2, 3, 9, 10	independent input or output
1Y, 2Y, 3Y, 4Y	1, 4, 8, 11	independent input or output
GND	7	ground (0 V)
1E, 2E, 3E, 4E	13, 5, 6, 12	enable input (active HIGH)
V _{CC}	14	supply voltage

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6. Functional description

Table 3.	Function table ^[1]	
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Input nE	Switch
L	OFF
Н	ON

[1] H = HIGH voltage level;

L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+11.0	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{SK}	switch clamping current	V_{SW} < –0.5 V or V_{SW} > V_{CC} + 0.5 V	-	±20	mA
I _{SW}	switch current	V_{SW} = -0.5 V to V_{CC} + 0.5 V	<u>[1]</u> -	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-	-50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2]	-	500
Р	power dissipation	per switch	-	100	mW

[1] To avoid drawing V_{CC} current out of terminal Z, when switch current flows in terminals Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{CC} current will flow out of terminals Yn. In this case there is no limit for the voltage drop across the switch, but the voltages at Yn and Z may not exceed V_{CC} or GND.

For SO14 packages: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For TSSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5.	Recommended	operating	conditions
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Symbol	Parameter	Conditions	74H	74HC4066-Q100			74HCT4066-Q100		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	10.0	4.5	5.0	5.5	V
VI	input voltage		GND	-	V _{CC}	GND	-	V _{CC}	V
V _{SW}	switch voltage		GND	-	V_{CC}	GND	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V
		V _{CC} = 10.0 V	-	-	35	-	-	-	ns/V

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9. Static characteristics

V _{is} is the ir V _{os} is the c For 74HC4	V_{IL} ; for test circuit see F_{ID} aput voltage at a Yn or Z putput voltage at a Yn or	terminal, whichever is assigned Z terminal, whichever is assigne = 2.0 V, 4.5 V, 6.0 V and 9.0 V.	as a	n input.		0			
Symbol	Parameter	Conditions		-40	°C to +85	S°C		to +125 C	Unit
				Min	Typ[1]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_{is} = V_{CC}$ to GND							
		V_{CC} = 2.0 V; I_{SW} = 100 μ A	[2]	-	-	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	54	-	118	142	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	42	-	105	126	Ω
		V_{CC} = 9.0 V; I_{SW} = 1000 μ A		-	32	-	88	105	Ω
R _{ON(rail)}	ON resistance (rail)	V _{is} = GND							
		V_{CC} = 2.0 V; I_{SW} = 100 μ A	[2]	-	80	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	35	-	95	115	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	27	-	82	100	Ω
		V_{CC} = 9.0 V; I_{SW} = 1000 μ A		-	20	-	70	85	Ω
		$V_{is} = V_{CC}$							
		V_{CC} = 2.0 V; I_{SW} = 100 μ A	[2]	-	100	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	42	-	106	128	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	35	-	94	113	Ω
		V_{CC} = 9.0 V; I_{SW} = 1000 μ A		-	20	-	78	95	Ω
ΔR_{ON}	ON resistance	$V_{is} = V_{CC}$ to GND							
	mismatch between channels	$V_{CC} = 2.0 V$	[2]	-	-	-	-	-	Ω
	GIAIIIEIS	$V_{CC} = 4.5 V$		-	5	-	-	-	Ω
		$V_{CC} = 6.0 V$		-	4	-	-	-	Ω
		$V_{CC} = 9.0 V$		-	3	-	-	-	Ω

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] At supply voltages (V_{CC} - GND) approaching 2 V, the analog switch ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using these supply voltages.

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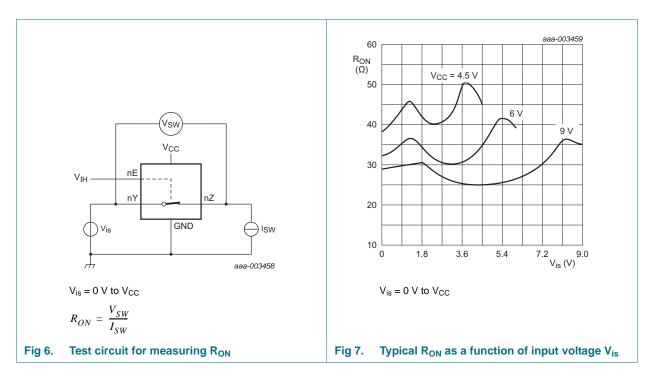


Table 7. Static characteristics 74HC4066-Q100

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
$T_{amb} = -40$	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	V
		V _{CC} = 9.0 V	6.3	4.7	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	0.8	0.5	V
		$V_{CC} = 4.5 V$	-	2.1	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.80	V
		$V_{CC} = 9.0 V$	-	4.3	2.70	V
l _l	input leakage current	$V_I = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	±1.0	μA
		$V_{CC} = 10.0 V$	-	-	±2.0	μA
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 10.0 V; V_I = V_{IH} or V_{IL} ; $ V_{SW} $ = V_{CC} – GND; see <u>Figure 8</u>				
		per channel	-	-	±1.0	μA
I _{S(ON)}	ON-state leakage current	V_{CC} = 10.0 V; V_{I} = V_{IH} or $V_{IL};$ $ V_{SW} $ = V_{CC} – GND; see <u>Figure 9</u>	-	-	±1.0	μA

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Table 7. Static characteristics 74HC4066-Q100 ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
I _{CC}	supply current	$V_1 = V_{CC}$ or GND; $V_{is} =$ GND or V_{CC} ; $V_{os} = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	20.0	μΑ
		$V_{CC} = 10.0 V$	-	-	40.0	μΑ
CI	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance		-	8	-	pF
T _{amb} = -40	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
		V _{CC} = 9.0 V	6.3	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.50	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.80	V
		$V_{CC} = 9.0 V$	-	-	2.70	V
lı	input leakage current	$V_I = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	±1.0	μΑ
		V _{CC} = 10.0 V	-	-	±2.0	μΑ
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 10.0 V; V _I = V _{IH} or V _{IL} ; V _{SW} = V _{CC} - GND; see <u>Figure 8</u>				
		per channel	-	-	±1.0	μA
I _{S(ON)}	ON-state leakage current	V_{CC} = 10.0 V; V _I = V _{IH} or V _{IL} ; V _{SW} = V _{CC} - GND; see <u>Figure 9</u>	-	-	±1.0	μΑ
lcc	supply current	$V_{I} = V_{CC}$ or GND; $V_{is} =$ GND or V_{CC} ; $V_{os} = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	40	μΑ
		V _{CC} = 10.0 V	-	-	80	μA

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

Table 8. Static characteristics 74HCT4066-Q100

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit		
$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$								
V _{IH}	HIGH-level input voltage	$V_{CC} = 4.5 V$ to 5.5 V	2.0	1.6	-	V		
V _{IL}	LOW-level input voltage	$V_{CC} = 4.5 V$ to 5.5 V	-	1.2	0.8	V		
li	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±1.0	μA		

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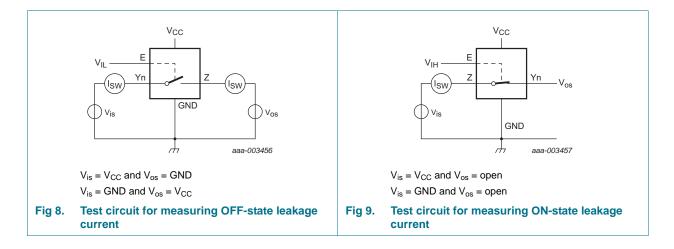
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Table 8. Static characteristics 74HCT4066-Q100 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 5.5 V; V _I = V _{IH} or V _{IL} ; $ V_{SW} $ = V _{CC} – GND; see <u>Figure 8</u>				
		per channel	-	-	±1.0	μΑ
I _{S(ON)}	ON-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 9$	-	-	±1.0	μA
I _{CC}	supply current	$ V_{I} = V_{CC} \text{ or GND}; V_{is} = GND \text{ or } V_{CC}; $	-	-	20.0	μΑ
ΔI_{CC}	additional supply current	per input pin; V _I = V _{CC} – 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V	-	100	450	μΑ
CI	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance		-	8	-	pF
T _{amb} = -40	0 °C to +125 °C					
VIH	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	-	-	0.8	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μΑ
$I_{S(OFF)}$	OFF-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 8$				
		per channel	-	-	±1.0	μΑ
I _{S(ON)}	ON-state leakage current	V_{CC} = 5.5 V; V _I = V _{IH} or V _{IL} ; $ V_{SW} = V_{CC} - GND$; see Figure 9	-	-	±1.0	μΑ
I _{CC}	supply current	$ V_{I} = V_{CC} \text{ or GND}; V_{is} = GND \text{ or } V_{CC}; $	-	-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; V _I = V _{CC} $- 2.1$ V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V	-	-	490	μΑ

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.



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10. Dynamic characteristics

Table 9. Dynamic characteristics 74HC4066-Q100

GND = 0 V; $t_r = t_f = 6 ns$; $C_L = 50 pF$ unless specified otherwise; for test circuit see <u>Figure 12</u>. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions		-40	°C to +85	°C	-40 °C to	°C to +125 °C	
			t	Min	Typ <mark>[1]</mark>	Max	Min	Мах	-
t _{pd} propagation delay	propagation delay	nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u>	[2]						•
		$V_{CC} = 2.0 V$		-	8	75	-	90	ns
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
		$V_{CC} = 6.0 V$		-	2	13	-	15	ns
		$V_{CC} = 9.0 V$		-	2	10	-	12	ns
t _{off} turn-off time	nE to nY or nZ; see Figure 11	[4]							
		$V_{CC} = 2.0 V$		-	44	190	-	225	ns
		$V_{CC} = 4.5 V$		-	16	38	-	45	ns
	$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	13	-	-	-	ns	
	$V_{CC} = 6.0 V$		-	13	33	-	38	ns	
		$V_{CC} = 9.0 V$		-	16	26	-	30	ns
t _{on}	turn-on time	nE to nY or nZ; see Figure 11	[3]						
		$V_{CC} = 2.0 V$		-	36	125	-	150	ns
		$V_{CC} = 4.5 V$		-	13	25	-	30	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	11	-	-	-	ns
		$V_{CC} = 6.0 V$		-	10	21	-	26	ns
		$V_{CC} = 9.0 V$		-	8	16	-	20	ns
C _{PD}	power dissipation capacitance	per switch; $V_I = GND$ to V_{CC}	<u>[5]</u>	11		-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

[3] t_{on} is the same as t_{PHZ} and t_{PLZ} .

[4] t_{off} is the same as t_{PZH} and t_{PZL} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$$\begin{split} P_{D} &= C_{PD} \times V_{CC}^{2} \times f_{i} + \sum \{(C_{L} + C_{sw}) \times V_{CC}^{2} \times f_{o}\} \text{ where:} \\ f_{i} &= \text{input frequency in MHz}; \end{split}$$

 $f_o =$ output frequency in MHz;

 Σ {(C_L + C_{sw}) × V_{CC}² × f_o} = sum of outputs;

 C_L = output load capacitance in pF;

 C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

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Table 10. Dynamic characteristics 74HCT4066-Q100

GND = 0 V; $t_r = t_f = 6$ ns; $C_L = 50$ pF unless specified otherwise; for test circuit see Figure 12. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions		-40) °C to +85	S°C	-40 °C to	o +125 °C	Unit
					Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u>	[2]						
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
toff turn-off time	nE to nY or nZ; see Figure 11	[4]							
		$V_{CC} = 4.5 V$		-	20	44	-	53	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	16	-	-	-	ns
t _{on}	turn-on time	nE to nY or nZ; see Figure 11	[3]						
		$V_{CC} = 4.5 V$		-	12	30	-	36	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	12	-	-	-	ns
C_{PD}	power dissipation capacitance	per switch; V _I = GND to (V _{CC} – 1.5 V)	[5]	-	12	-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

[3] t_{on} is the same as t_{PHZ} and t_{PLZ} .

[4] t_{off} is the same as $t_{PZH and} t_{PZL}$.

 V_{CC} = supply voltage in V.

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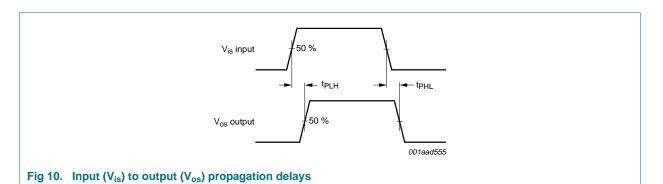
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11. Waveforms



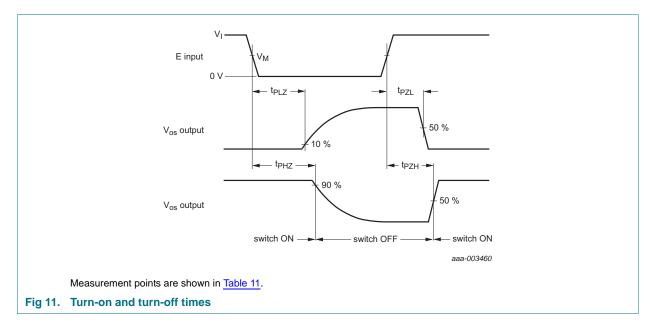


Table 11. Measurement points

Туре	VI	V _M
74HC4066-Q100	V _{CC}	0.5V _{CC}
74HCT4066-Q100	3.0 V	1.3 V

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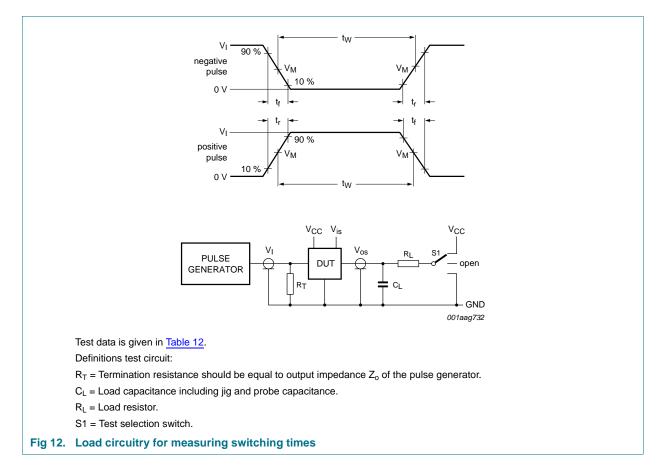


Table 12. Test data

Test	Input			Output		S1 position
	Control E	Switch Yn (Z)	t _r , t _f	Switch Z (Yn)	Switch Z (Yn)	
	V <u>[^{1]}</u>	V _{is}		CL	RL	
t _{PHL} , t _{PLH}	GND	GND to V _{CC}	6 ns	50 pF	-	open
t _{PHZ} , t _{PZH}	GND to V _{CC}	V _{CC}	6 ns	50 pF, 15 pF	1 kΩ	GND
t _{PLZ} , t _{PZL}	GND to V _{CC}	GND	6 ns	50 pF, 15 pF	1 kΩ	V _{CC}

[1] For 74HCT4066-Q100: maximum input voltage $V_1 = 3.0$ V.

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12. Additional dynamic characteristics

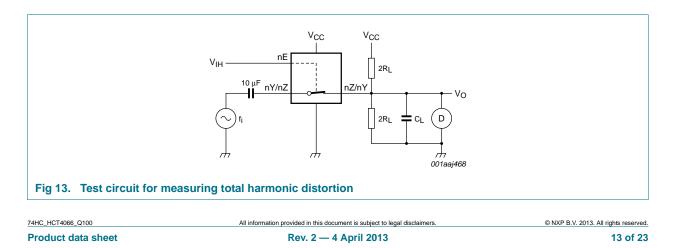
Table 13. Additional dynamic characteristics

Recommended conditions and typical values; GND = 0 V; $T_{amb} = 25 °C$. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

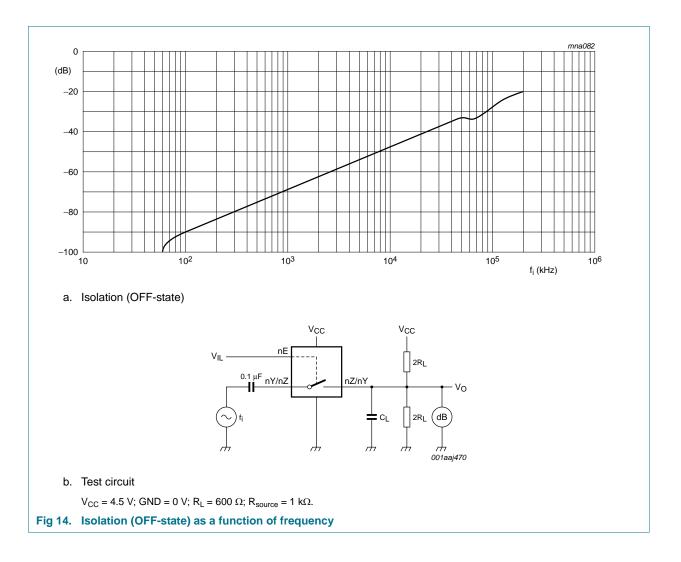
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 1 \text{ kHz}; \text{ R}_L = 10 \text{ k}\Omega; \text{ C}_L = 50 \text{ pF};$ see Figure 13				%
		V _{CC} = 4.5 V; V _I = 4.0 V (p-p)	-	0.04	-	%
		V _{CC} = 9.0 V; V _I = 8.0 V (p-p)	-	0.02	-	%
		$\label{eq:fi} \begin{split} f_i &= 10 \text{ kHz}; \text{R}_\text{L} = 10 \text{k}\Omega; \text{C}_\text{L} = 50 \text{pF}; \\ \text{see } \overline{\text{Figure 13}} \end{split}$				
		V _{CC} = 4.5 V; V _I = 4.0 V (p-p)	-	0.12	-	%
		V _{CC} = 9.0 V; V _I = 8.0 V (p-p)	-	0.06	-	%
f _(-3dB)	: _(-3dB) –3 dB frequency response	$R_L = 50 \Omega$; $C_L = 10 pF$; see <u>Figure 15</u>	[2]			
		$V_{CC} = 4.5 V$	-	180	-	MHz
		V _{CC} = 9.0 V	-	200	-	MHz
α_{iso}	isolation (OFF-state)	$R_L = 600 \Omega$; $C_L = 50 pF$; $f_i = 1 MHz$; see <u>Figure 14</u>	[1]			
		$V_{CC} = 4.5 V$	-	-50	-	dB
		V _{CC} = 9.0 V	-	-50	-	dB
V _{ct}	crosstalk voltage	between digital input and switch (peak to peak value); $R_L = 600 \Omega$; $C_L = 50 pF$; $f_i = 1 MHz$; see Figure 16				
		$V_{CC} = 4.5 V$	-	110	-	mV
		V _{CC} = 9.0 V	-	220	-	mV
Xtalk crosstalk		between switches; R _L = 600 Ω ; C _L = 50 pF; f _i = 1 MHz; see <u>Figure 17</u>	[1]			
		V _{CC} = 4.5 V	-	-60	-	dB
		$V_{CC} = 9.0 V$	-	-60	-	dB

[1] Adjust input voltage V_{is} to 0 dBm level (0 dBm = 1 mW into 600 Ω).

[2] Adjust input voltage V_{is} to 0 dBm level at V_{os} for $f_i = 1$ MHz (0 dBm = 1 mW into 50 Ω). After set-up, f_i is increased to obtain a reading of -3 dB at V_{os}.

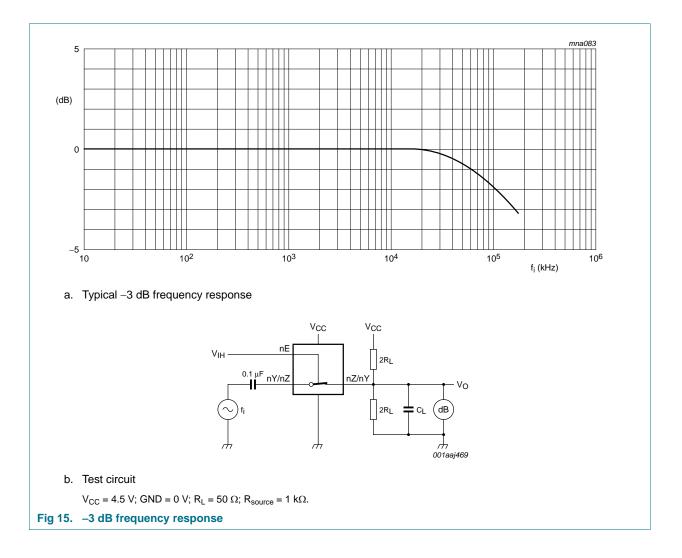


Quad single-pole single-throw analog switch



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Quad single-pole single-throw analog switch



Quad single-pole single-throw analog switch

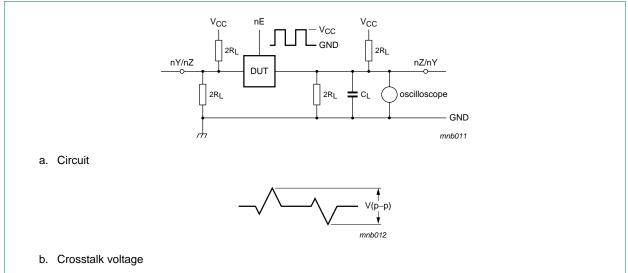
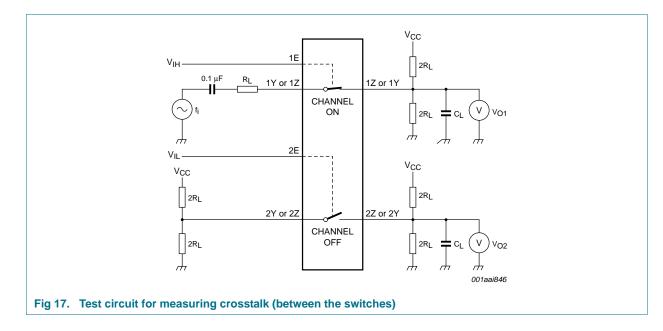


Fig 16. Test circuit for measuring crosstalk voltage (between the digital input and the switch)



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13. Package outline

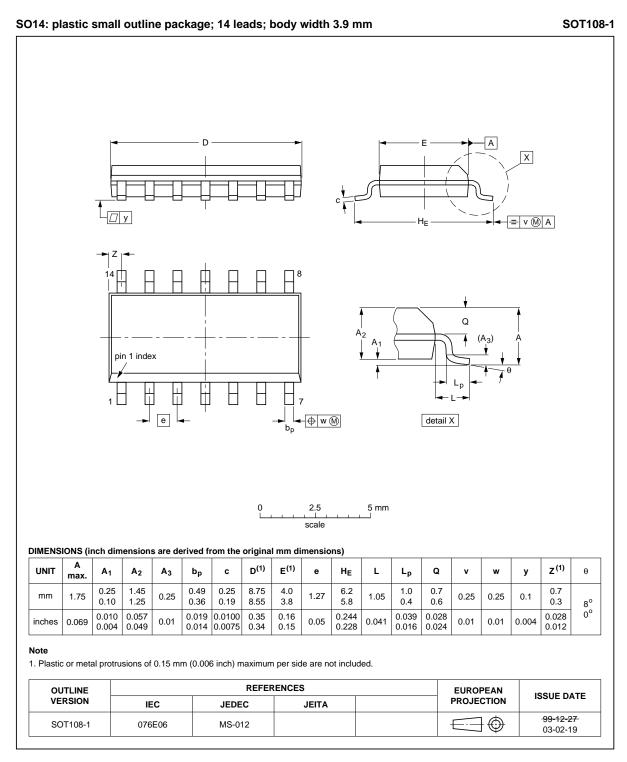


Fig 18. Package outline SOT108-1 (SO14)

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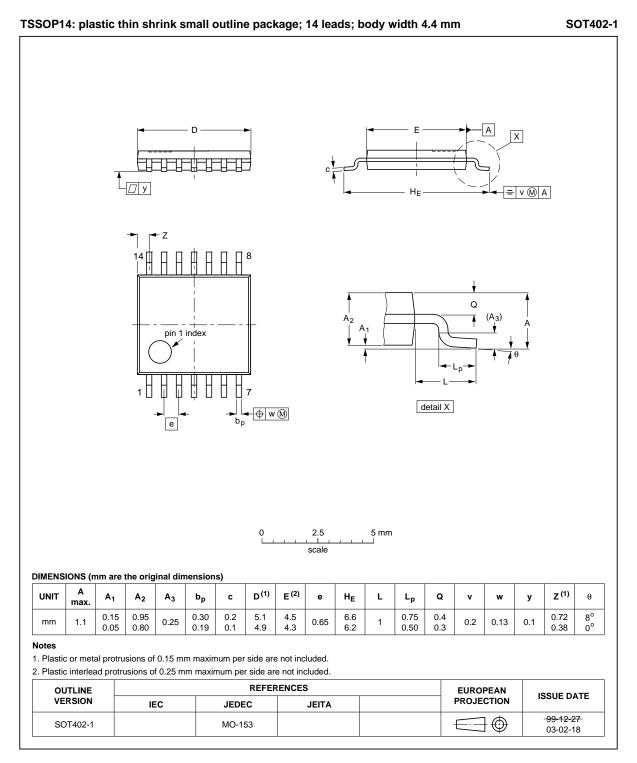
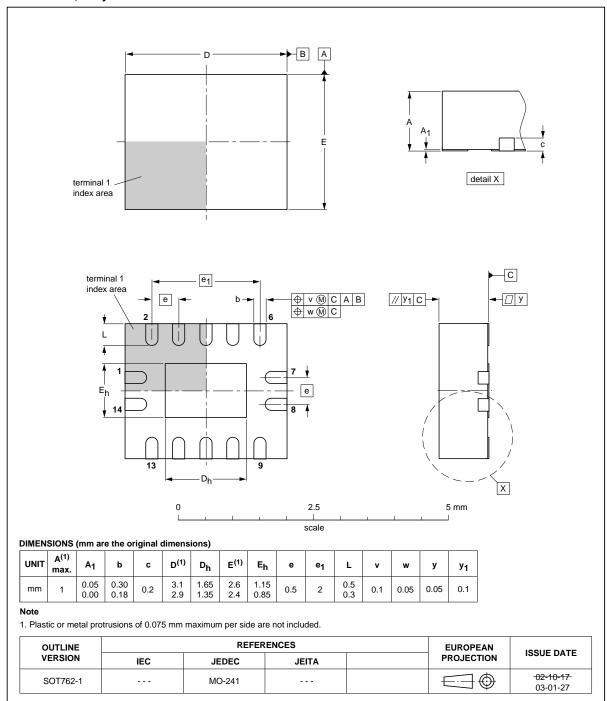


Fig 19. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 20. Package outline SOT762-1 (DHVQFN14)

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14. Abbreviations

reviations
Description
Complementary Metal Oxide Semiconductor
ElectroStatic Discharge
Human Body Model
Machine Model
Charge-Device Model
Military

15. Revision history

Table 15. Revision histor	у			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4066_Q100 v.2	20130404	Product data sheet	-	74HC_HCT4066_Q100 v.1
Modifications:	 Descriptive tit 	tle corrected (errata).		
	 New general 	description (errata).		
74HC_HCT4066_Q100 v.1	20120712	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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